


## Features

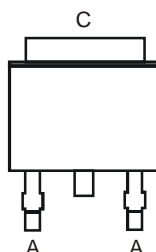
- Ultra-Fast Die Construction
- Soft, Fast Switching Capability
- Low Leakage Current
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**

## Mechanical Data




- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 
- Polarity: See Diagram



Top View



Top View  
Pin-Out

LEFT PIN  RIGHT PIN   **BOTTOMSIDE  
HEAT SINK**

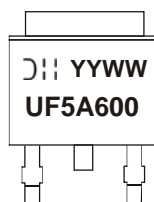
**Note:** Pins Left & Right must be electrically connected at the printed circuit board.


## Ordering Information (Note 2)

Part Number	Case	Packaging
UF5A600D1-13	TO252	2500 pieces/reel

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.  
2. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information



UF5A600 = Product Type Marking Code  
 = Manufacturers' Code Marking  
 YYWW = Date code marking  
 YY = Last two digits of year (ex: 09 for 2009)  
 WW = Week code (01 - 53)

**Maximum Ratings** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	600	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_R$		
Average Rectified Output Current	$I_O$	5	A
Non-Repetitive Peak Forward Surge Current	$I_{FSM}$	100	A
8.3ms Single Half Sine-Wave Superimposed on Rated Load			

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
Typical Thermal Resistance Junction to Ambient (Note 3)	$R_{\theta JA}$	34	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +175	$^\circ\text{C}$

**Electrical Characteristics** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage	$V_F$	—	1.4	1.9	V	$I_F = 5\text{A}, T_J = 25^\circ\text{C}$
		—	1.1	1.75		$I_F = 5\text{A}, T_J = 125^\circ\text{C}$
Reverse Leakage Current (Note 4)	$I_R$	—	—	10	$\mu\text{A}$	$V_R = 600\text{V}, T_J = 25^\circ\text{C}$
		—	—	0.2	mA	$V_R = 600\text{V}, T_J = 125^\circ\text{C}$
Reverse Recovery Time	$t_{rr}$	—	22	30	ns	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$
		—	20	25		$I_F = 1\text{A}, V_R = 30\text{V}, di/dt = 100\text{A}/\mu\text{s}$
Maximum Junction Capacitance	$C_J$	—	27	50	pf	$V_R = 10\text{V}_{DC}, f = 1\text{MHz}$

Notes: 3. Device mounted on Polymide PCB, with 16X recommended pad layout.  
 4. Short duration pulse test used to minimize self-heating effect.

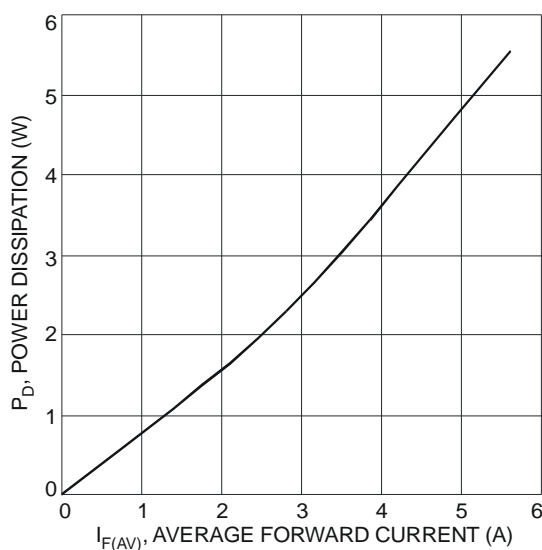


Fig. 1 Forward Power Dissipation

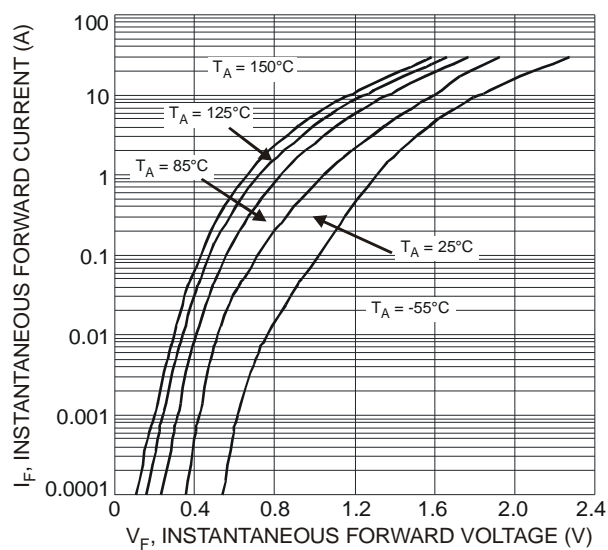


Fig. 2 Typical Forward Characteristics

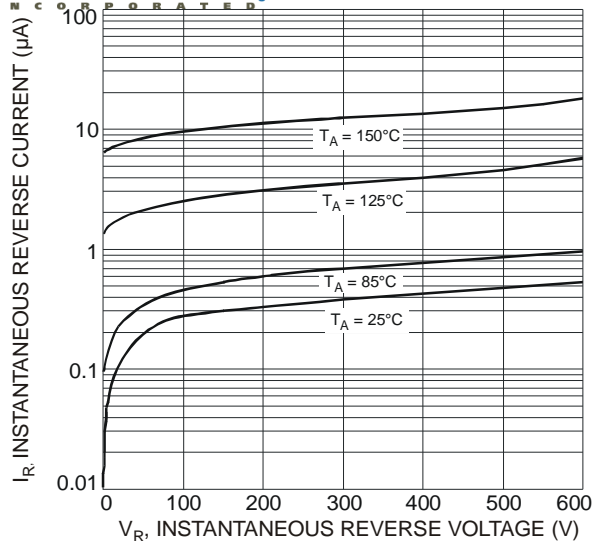


Fig. 3 Typical Reverse Characteristics

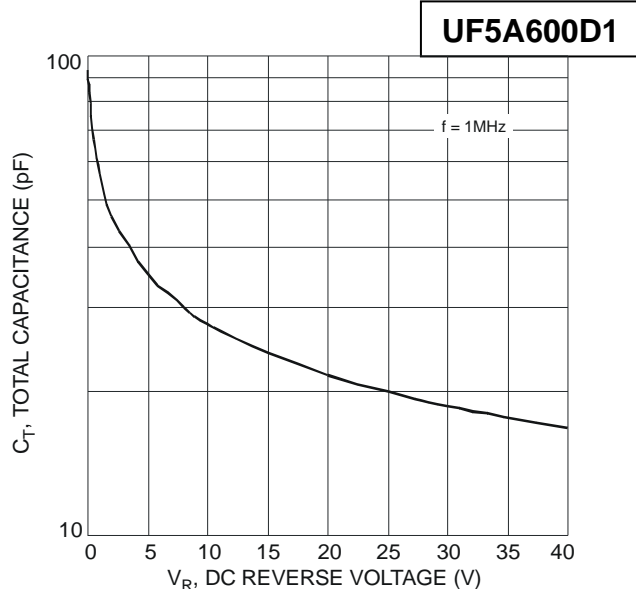


Fig. 4 Total Capacitance vs. Reverse Voltage

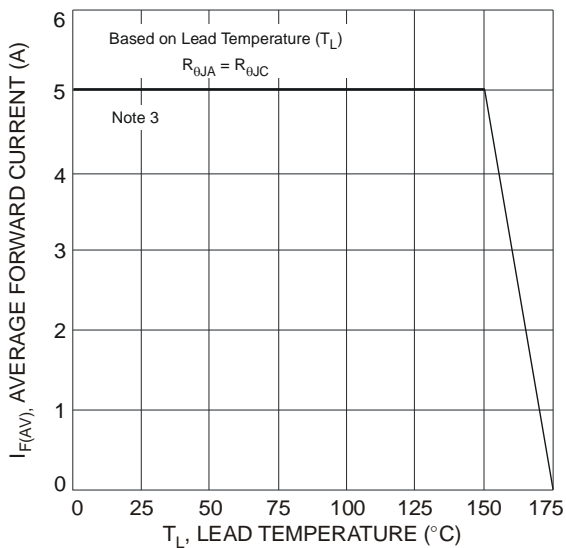


Fig. 5 Forward Current Derating Curve

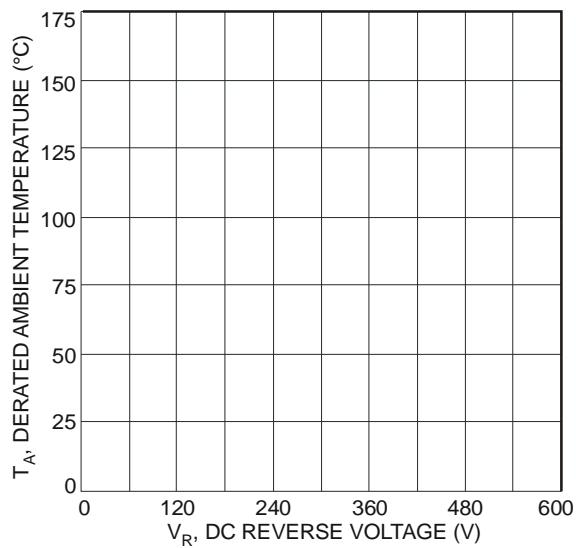
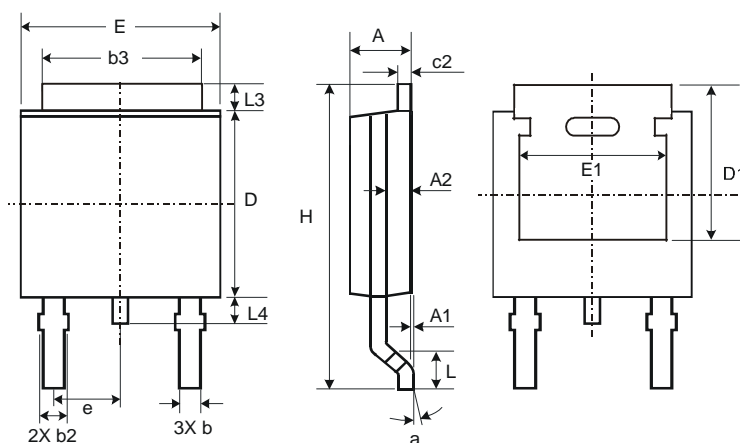


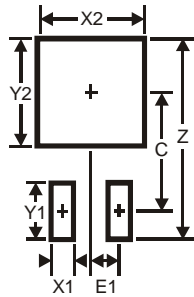
Fig. 6 Operating Temperature Derating

## Package Outline Dimensions



TO252			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c2	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	—	—
e	—	—	2.286
E	6.45	6.70	6.58
E1	4.32	—	—
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	—
All Dimensions in mm			

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	11.6
X1	1.5
X2	7.0
Y1	2.5
Y2	7.0
C	6.9
E1	2.3

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